Unit: mm

TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOS V)

TPC8122

Lithium Ion Battery Applications Notebook PC Applications

• Small footprint due to small and thin package

• Low drain-source ON resistance: $RDS(ON) = 6.3 \text{ m}\Omega \text{ (typ.)}$

• High forward transfer admittance: $|Y_{fs}| = 30S$ (typ.)

• Low leakage current: $IDSS = -10\mu A \text{ (max) (VDS} = -30 \text{ V)}$

• Enhancement mode: $V_{th} = -0.8 \text{ to } -2.0 \text{ V (V}_{DS} = -10 \text{ V}, I_D = -1 \text{ mA)}$

Maximum Ratings (Ta = 25°C)

Characteri	stics	Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	-30	V	
Drain-gate voltage (Ro	_{SS} = 20 kΩ)	V_{DGR}	-30	V	
Gate-source voltage		V_{GSS}	±20	٧	
Drain current	DC (Note 1)	ΙD	-12	Α	
Drain current	Pulse (Note 1)	I _{DP}	-48		
Drain power dissipatio	n (t = 10 s) (Note 2a)	P_{D}	1.9	W	
Drain power dissipatio	n (t = 10 s) (Note 2b)	P _D	1.0	W	
Single pulse avalanche	e energy (Note 3)	E _{AS}	93	mJ	
Avalanche current		I _{AR}	-12	Α	
Repetitive avalanche (N	energy lote 2a) (Note 4)	E _{AR}	0.030	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature r	ange	T _{stg}	-55 to 150	°C	

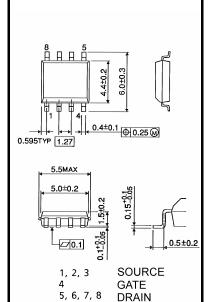
Note 1, Note 2, Note 3 and Note 4: See the next page.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating

temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

This transistor is an electrostatic-sensitive device. Please handle with caution.

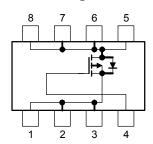


Weight: 0.080 g (typ.)

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Circuit Configuration

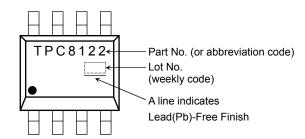
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Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R _{th (ch-a)}	65.8	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	R _{th (ch-a)}	125	°C/W

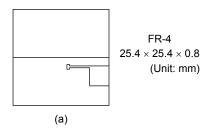
Marking (Note 5)

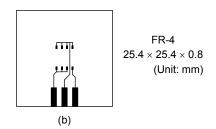


Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2:

(a) Device mounted on a glass-epoxy board (a) (b) Device mounted on a glass-epoxy board (b)



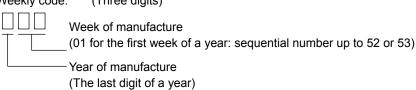


Note 3: $V_{DD} = -24~V,~T_{ch} = 25^{\circ}C$ (initial), L =500 μ H, RG = 25 $\Omega,~I_{AR} = -12~A$

Note 4: Repetitive rating; pulse width limited by maximum channel temperature

Note 5: • on lower left of the marking indicates Pin 1.

Weekly code: (Three digits)





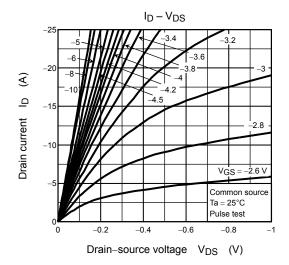
Electrical Characteristics (Ta = 25°C)

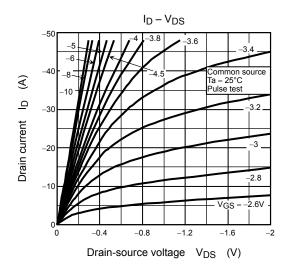
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage curre	nt	I _{GSS}	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±100	nA	
Drain cut-OFF curre	ent	I _{DSS}	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$	_	_	-10	μА	
Drain-source breakdown voltage		V _{(BR) DSS}	$I_D = -10$ mA, $V_{GS} = 0$ V	-30	_		V	
Diain-source break	down voltage	V _{(BR) DSX}	$I_D = -10 \text{ mA}, V_{GS} = 20 \text{ V}$	-13	- - -30 - -13 -	V		
Gate threshold volt			$V_{DS} = -10 \text{ V}, I_D = -1 \text{ mA}$	-0.8		-2.0	V	
Drain course ON registence		D	$V_{GS} = -4 \text{ V}, I_D = -6 \text{ A}$	_	11.5	16.5	- mΩ	
Diam-source Oil ie	vard transfer admittance		$V_{GS} = -10 \text{ V}, I_D = -6 \text{ A}$	_	6.3	8		
Forward transfer admittance		Y _{fs}	$V_{DS} = -10 \text{ V}, I_D = -6 \text{ A}$	15	30	_	S	
Input capacitance		C _{iss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz	_	2450	_	pF	
Reverse transfer capacitance		C _{rss}		_	530	_		
Output capacitance		C _{oss}		_	740	_		
Drain cut-OFF current IDSS VDS = -30 V, VGS = 0 V — — Drain-source breakdown voltage V (BR) DSS ID = -10 mA, VGS = 0 V —30 — V (BR) DSX ID = -10 mA, VGS = 20 V —13 — Gate threshold voltage Vth VDS = -10 V, ID = -1 mA —0.8 — Drain-source ON resistance RDS (ON) VGS = -4 V, ID = -6 A — 11.5 VGS = -10 V, ID = -6 A — 6.3 — 6.3 Forward transfer admittance IYfsl VDS = -10 V, ID = -6 A — 2450 Input capacitance Crss VDS = -10 V, VGS = 0 V, f = 1 MHz — 530 Output capacitance Coss — 740 Rise time tr VGS = -10 V — — - 22 Switching time ton Turn-ON time ton — — - 22	Rise time	t _r	V_{CS} 0 V Γ $I_D = -6 \text{ A}$	_	12	_		
	_							
	Fall time	t _f	, ο α	_	150	_	ns	
	Turn-OFF time	t _{off}		_	360	_		
					62	_	nC	
Gate-source charge 1		Q _{gs1}		_	10	_		
Gate-drain ("miller") charge		Q _{gd}			19			

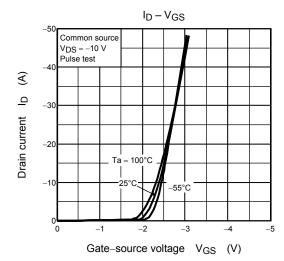
Source-Drain Ratings and Characteristics (Ta = 25°C)

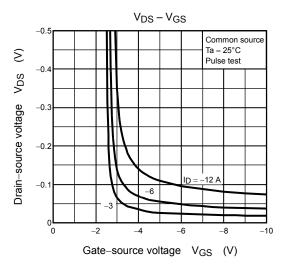
Charac	teristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse	(Note 1)	I _{DRP}	_	_	_	-48	Α
Forward voltage (diod	de)		V _{DSF}	$I_{DR} = -12 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	1.2	V

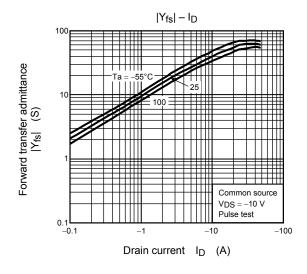
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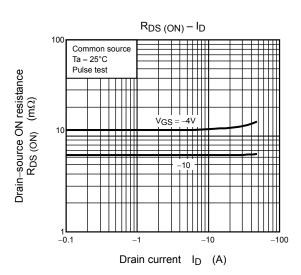




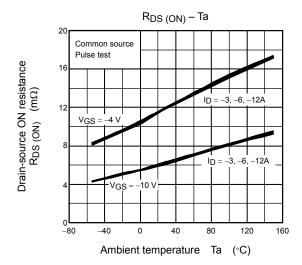


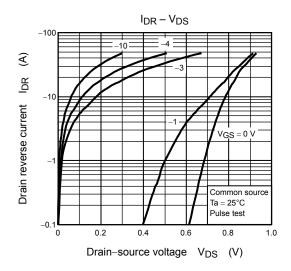


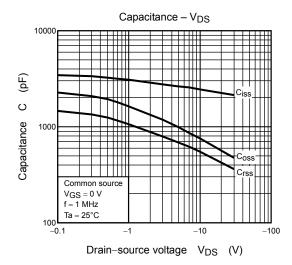


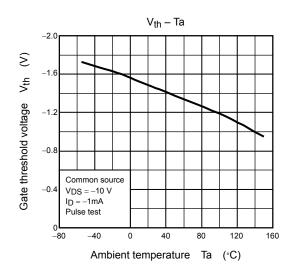


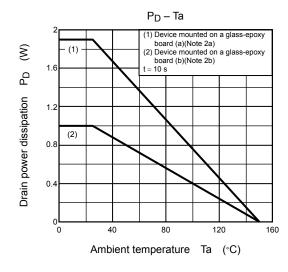
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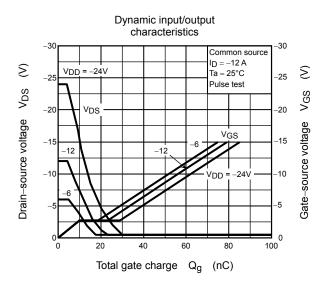


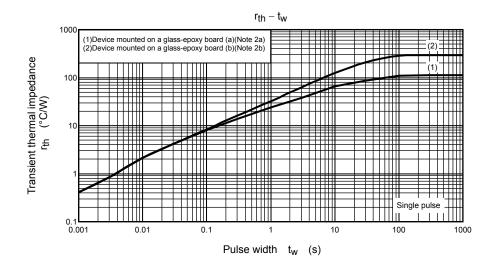


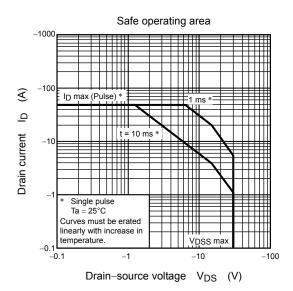












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